

S/N 10/728437



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: James M. Cleeves et al. Examiner: Unknown
Serial No.: 10/728437 Group Art Unit: 2812
Filed: December 5, 2003 Docket: MA-110
Title: Optimization of Critical Dimensions and Pitch of Patterned Features in and Above
a Substrate

COMMUNICATION RE: INCORRECT FILING RECEIPT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicants hereby request correction of the Filing Receipt with respect to the above-identified patent application. In the Filing Receipt received March 16, 2004, (copy enclosed), the order of inventors is incorrect.

The first named inventor should be James M. Cleeves.

The second named inventor should be Roy E. Scheuerlein

Applicants would appreciate the above-identified error be corrected and that a new "corrected" filing receipt be sent to Applicants' representatives at the address given below.

Respectfully submitted,

Pamela J. Squyres

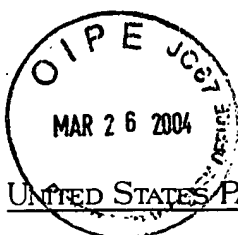
Reg. No.: 52,246

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 22 day of March, 2004.

Pamela J. Squyres

Name

Signature



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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/728,437	12/05/2003	2812	1860	MA-110	8	59	6

CONFIRMATION NO. 9392

Matrix Semiconductor, Inc.
 3230 Scott Blvd
 Santa Clara, CA 95054

FILING RECEIPT



OC000000012073561

Date Mailed: 03/12/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. **If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).**

Applicant(s)

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1. JAMES M. CLEEVES
 2. ROY E. SCHEUERLEIN

Assignment For Published Patent Application

Matrix Semiconductor, Inc., Santa Clara, CA;

Domestic Priority data as claimed by applicant

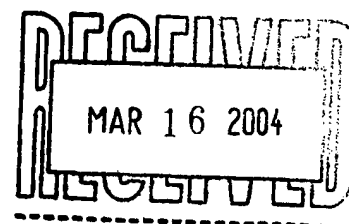
Foreign Applications

If Required, Foreign Filing License Granted: 03/10/2004

Projected Publication Date: To Be Determined - pending completion of Missing Parts

Non-Publication Request: No

Early Publication Request: No



Title

Optimization of critical dimensions and pitch of patterned features in and above a substrate

Preliminary Class